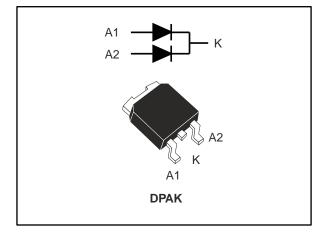


# Automotive ultrafast recovery diode

Datasheet - production data



### Features



- AEC-Q101 qualified
- Suited for SMPS
- Low losses
- Low forward and reverse recovery time
- High surge current capability
- High junction temperature
- PPAP capable

## Description

This dual center tap diode is suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use in low voltage high frequency inverters, freewheeling and polarity protection for automotive applications.

	Table	1:	Device	summary
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Symbol	Value
lf(AV)	2 x 3 A
Vrrm	200 V
V <sub>F</sub> (typ.)	0.80 V
Tj(max.)	175 °C
T <sub>rr</sub> (typ.)	14 ns

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This is information on a product in full production.

# 1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit		
Vrrm	Repetitive peak reverse voltage		200	V	
I <sub>F(RMS)</sub>	Forward rms current		11	А	
	Average forward current	T <sub>c</sub> = 160 °C	3	٨	
IF(AV)	$\delta$ = 0.5, square wave	T <sub>c</sub> = 155 °C	6	A	
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		60	А	
T <sub>stg</sub>	Storage temperature range	-65 to +175	°C		
Tj	Operating junction temperature range	-40 to +175	°C		

### Table 3: Thermal parameters

Symbol	Parameter	Max. value	Unit	
Durin	lunction to enco	Per diode	5	
R <sub>th(j-c)</sub>	Junction to case	Per device	3	°C/W
R <sub>th(c)</sub>	Coupling		1	

When the two diodes 1 and 2 are used simultaneously:

 $\Delta T_{j}(diode 1) = P (diode 1) \times R_{th(j-c)} (Per diode) + P (diode 2) \times R_{th(c)}$ 

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
IR <sup>(1)</sup>	Reverse leakage current	Tj = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-		3	μA
IR		Tj = 125 °C	VR = VRRM	-	3	30	
		T <sub>j</sub> = 25 °C	IF = 3 A IF = 6 A	-	0.98	1.1	
VF <sup>(2)</sup>		T <sub>j</sub> = 150 °C		-	0.8	0.95	V
VFV Forward Voltage did	Forward voltage drop	Tj = 25 °C		-	1.1	1.25	v
		T <sub>j</sub> = 150 °C		-	0.9	1.05	

#### Notes:

$$\label{eq:point} \begin{split} \mbox{$^{(1)}$Pulse test: $t_p = 5$ ms, $\delta < 2\%$} \\ \mbox{$^{(2)}$Pulse test: $t_p = 380$ µs, $\delta < 2\%$} \end{split}$$

To evaluate the conduction losses, use the following equation:

 $P = 0.85 \text{ x } I_{F(AV)} + 0.033 \text{ x } I_{F^{2}(RMS)}$ 

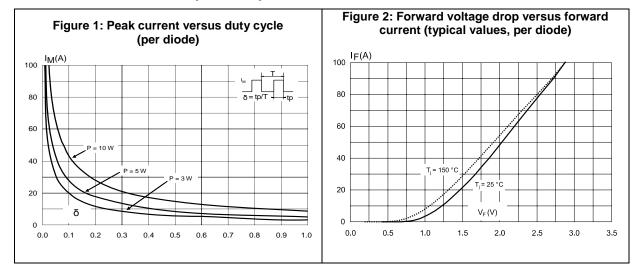


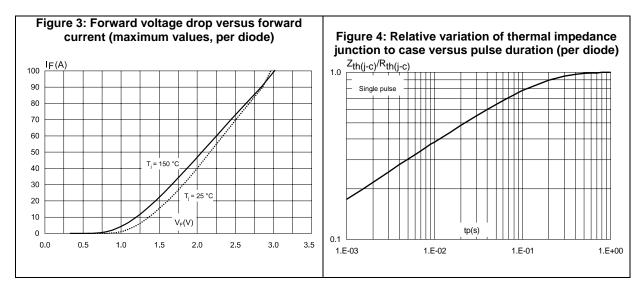
### Characteristics

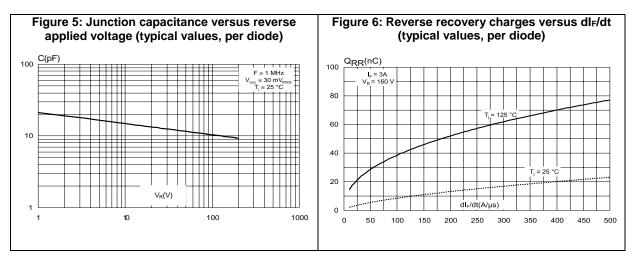
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
		$ \begin{array}{l} I_{F} = 1 \ A, \\ dI_{F}/dt = -100 \ A/\mu s, \\ V_{R} = 30 \ V, \ T_{j} = 25 \ ^{\circ}C \end{array} $	-	14	20	2
trr F	Reverse recovery time	$\label{eq:IF} \begin{array}{l} I_F = 1 \ A, \\ dI_F/dt = -50 \ A/\mu s, \\ V_R = 30 \ V, \ T_j = 25 \ ^\circ C \end{array}$	-	21	30	ns
I <sub>RM</sub>	Reverse recovery current	I <sub>F</sub> = 3 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 160 V, T <sub>j</sub> = 125 °C	-	4	5.5	А
t <sub>fr</sub>	Forward recovery time	IF = 3 A, dIF/dt = 200 A/µs VFR = 1.1 x VFmax, Tj = 25 °C	-	24		ns
Vfp	Forward recovery voltage	$I_F = 3 \text{ A}, \\ dI_F/dt = 200 \text{ A}/\mu\text{s}, T_j = 25 \text{ °C}$	-	3.7		V



### 1.1 Characteristics (curves)



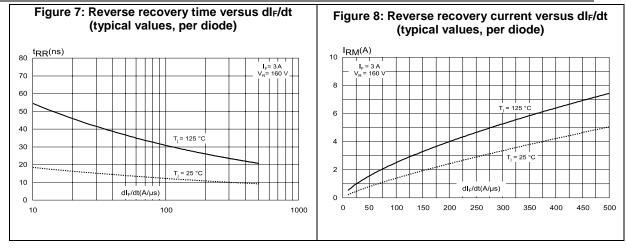


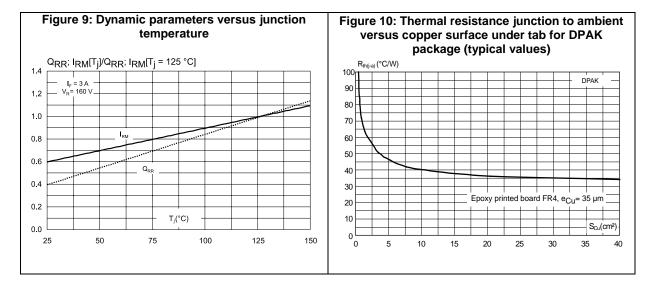


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#### Characteristics





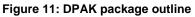


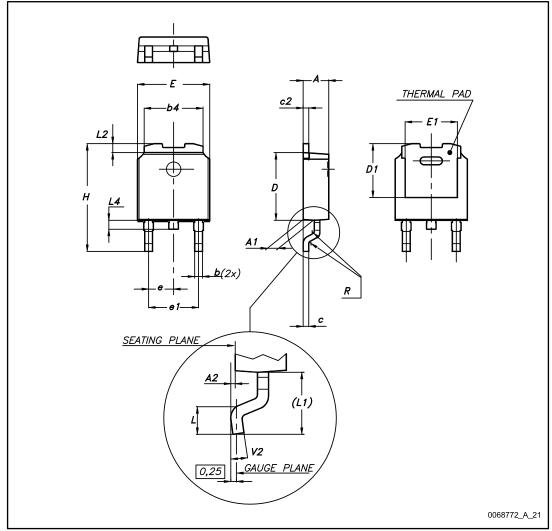
# 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

## 2.1 DPAK package information

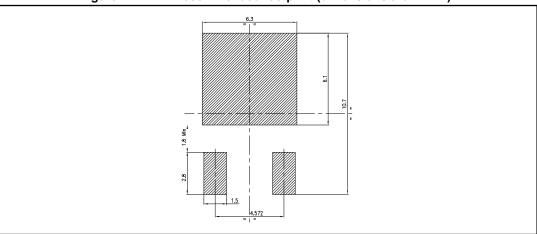






### Package information

Table 6: DPAK mechanical data						
Dimensions						
Dim.		Millimeters	;		Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.20		2.40	0.087		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	5.20		5.40	0.205		0.213
С	0.45		0.60	0.018		0.024
c2	0.48		0.60	0.019		0.024
D	6.00		6.20	0.236		0.244
D1	4.95	5.10	5.25	0.195	0.201	0.207
E	6.40		6.60	0.252		0.260
E1	5.10	5.20	5.30	0.201	0.205	0.209
е	2.16	2.28	2.40	0.085	0.090	0.094
e1	4.40		4.60	0.173		0.181
Н	9.35		10.10	0.368		0.398
L	1.00		1.50	0.039		0.059
(L1)	2.60	2.80	3.00	0.102	0.110	0.118
L2	0.65	0.80	0.95	0.026	0.031	0.037
L4	0.60		1.00	0.024		0.039
R		0.20			0.008	
V2	0°		8°	0°		8°



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# **3** Ordering information

Table 7: Ordering information						
Order code	Marking	Package	Weight	Base qty.	Delivery mode	
STTH602CBY-TR	STTH6 02CBY	DPAK	0.30 g	2500	Tape and reel	

# 4 Revision history

### Table 8: Document revision history

Date	Revision	Changes	
24-Oct-2012	1	First issue.	
16-Mar-2017	2	Updated <i>Table 3: "Thermal parameters".</i> Minor text changes.	



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